Application No. 10/766466 February 10, 2006 YR CLMPTO

1. (Currently Amended) A semiconductor device comprising: a substrate of a first conductivity type;

an epitaxial layer of said first conductivity type formed over a major surface of said substrate;

a plurality of stripes of a second conductivity type only being formed in a top surface of said epitaxial layer, each of said regions stripes of said second conductivity type extending to a first depth and laterally spaced from another region stripe of said second conductivity type by a distance selected so that said device exhibits the same reverse avalanche energy absorption characteristics as a Fast Recovery Epitaxial Diode having a diffusion of a depth higher than said first depth; and

a schottky contact layer in contact with said plurality of spaced regions stripes of said second conductivity type and regions of said first conductivity type disposed between said spaced regions stripes of said second conductivity type.

2.-3. (Canceled).

- 4. (Previously Presented) A semiconductor device according to claim 1, wherein said stripes of said second conductivity type are five microns deep.
- 5. (Original) A semiconductor device according to claim 1, wherein said schottky contact layer is comprised of aluminum.
- 6. (Previously Presented) A semiconductor device according to claim 1, wherein said distance between a stripe of said second conductivity type and another stripe of said second conductivity type is eight microns.

- 7. (Previously Presented) A semiconductor device according to claim 1, wherein said distance between a stripe of said second conductivity type and another stripe of said second conductivity type is twelve microns.
- 8. (Previously Presented) A semiconductor device according to claim 1, wherein said distance between a stripe of said second conductivity type and another stripe of said second conductivity type is nincteen microns.
- 9. (Previously Presented) A semiconductor device according to claim 1, wherein said distance between said stripes of said second conductivity type is between eight microns and nineteen microns.
- 10. (Previously Presented) A semiconductor device according to claim 1, wherein said distance between a stripe of said second conductivity type and another stripe of said second conductivity type is no more than nineteen microns.
- 11. (Original) A semiconductor device according to claim 1, further comprising a back contact layer disposed over a second major surface of said substrate opposing said first major surface.

Claims 12-22 (CANCELLED)